To ICDCM 2019 committee

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# **The 3rd IEEE International Conference on DC Microgrids**

# **Exhibition Application form**

In accordance with "Exhibition Information", we will apply as follows.

|  |  |
| --- | --- |
| Application Date |  |
| Corporation | Name |  |
| URL |  |
| Address |  |
| Contact Person | Name |  |
| Division |  |
| TEL |  |
| FAX |  |
| E-mail |  |
| Number of booths applied |  | (JPY50,000 per booth) |
| Exhibit Contents |  |
| Remarks |  |

※Personal information you fill in will be used only for business related to ICDCM2019.

※After receipt of application, we will send an invoice for exhibition fee from the committee.